SPECIFICATIONS FOR NICHIA YELLOW LED MODEL: NSPY800AS

NICHIA CORPORATION

1.SPECIFICATIONS

(1) Absolute Maximum Ratings

 $(Ta=25^{\circ}C)$

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Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	50	mA
Pulse Forward Current	IFP	200	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	130	mW
Operating Temperature	Topr	-30 ~ + 85	°C
Storage Temperature	Tstg	-40 ~ +100	°C
Soldering Temperature	Tsld	265°C for 10sec.	

IFP Conditions : Pulse Width ≤ 10 msec. and Duty $\leq 1/10$

(2) Initial Electrical/Optical Characteristics

 $(Ta=25^{\circ}C)$

Item		Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage		VF	IF=20[mA]	-	2.1	2.6	V
Reverse Current		Ir	$V_R = 5[V]$	ı	ı	50	μΑ
Luminous Intensity	Rank F	Iv	IF=20[mA]	1300	2600	-	mcd

^{*} Luminous Intensity Measurement allowance is \pm 10%.

Color Rank (IF=20mA,Ta=25°C)

•			`		· · · · · · · · · · · · · · · · · · ·		
		Rank L					
	X	0.603	0.532	0.522	0.589		
	у	0.397	0.467	0.460	0.393		

^{*} Color Coordinates Measurement allowance is ± 0.01 .

Average Value by Shipment Lot

 $(IF=20mA,Ta=25^{\circ}C)$

		(11 2011111,1111 20 0)
Item	Symbol	Average Control
Color Coordinates	X	(x, y) conforms to
(Average)	${y}$	the ITE yellow color requirement.
Luminous Intensity (Average)	- Iv	

2.TYPICAL INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS

Please refer to figure's page.

3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to figure's page.

Material as follows; Resin(Mold): Epoxy Resin

Leadframe : Ag plating Copper Alloy

4.PACKAGING

· The LEDs are packed in cardboard boxes after packaging in anti-electrostatic bags. Please refer to figure's page.

The label on the minimum packing unit shows; Part Number, Lot Number, Ranking, Quantity

- · In order to protect the LEDs from mechanical shock, we pack them in cardboard boxes for transportation.
- The LEDs may be damaged if the boxes are dropped or receive a strong impact against them, so precautions must be taken to prevent any damage.
- · The boxes are not water resistant and therefore must be kept away from water and moisture.
- · When the LEDs are transported, we recommend that you use the same packing method as Nichia.

5.LOT NUMBER

The first six digits number shows **lot number**.

The lot number is composed of the following characters;

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    ○□×××× - △■
    ○ - Year (3 for 2003, 4 for 2004)
    □ - Month (1 for Jan., 9 for Sep., A for Oct., B for Nov.)
    ×××× - Nichia's Product Number
    △ - Ranking by Color Coordinates
    ■ - Ranking by Luminous Intensity
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6.RELIABILITY

(1) TEST ITEMS AND RESULTS

	Standard			Number of
Test Item	Test Method	Test Conditions	Note	Damaged
Resistance to	JEITA ED-4701	Tsld= 260 ± 5 °C, 10 sec.	1 time	0/100
Soldering Heat	300 302	3mm from the base of the epoxy bulb		
Solderability	JEITA ED-4701	Tsld= $235 \pm 5^{\circ}$ C, 5sec.	1 time	0/100
	300 303	(using flux)	over 95%	
Thermal Shock	JEITA ED-4701	0°C ~ 100°C	100 cycles	0/100
	300 307	15sec. 15sec.		
Temperature Cycle	JEITA ED-4701	-40°C ~ 25°C ~ 100°C ~ 25°C	100 cycles	0/100
	100 105	30min. 5min. 30min. 5min.		
Moisture Resistance Cyclic	JEITA ED-4701	25°C ~ 65°C ~ -10°C	10 cycles	0/100
	200 203	90%RH 24hrs./1cycle		
Terminal Strength	JEITA ED-4701	Load 5N (0.5kgf)	No noticeable	0/100
(bending test)	400 401	$0^{\circ} \sim 90^{\circ} \sim 0^{\circ}$ bend 2 times	damage	
Terminal Strength	JEITA ED-4701	Load 10N (1kgf)	No noticeable	0/100
(pull test)	400 401	10 ± 1 sec.	damage	
High Temperature Storage	JEITA ED-4701	Ta=100°C	1000hrs.	0/100
	200 201			
Temperature Humidity	JEITA ED-4701	Ta=60°C, RH=90%	1000hrs.	0/100
Storage	100 103			
Low Temperature Storage	JEITA ED-4701	Ta=-40°C	1000hrs.	0/100
	200 202			
Steady State Operating Life		Ta=25°C, IF=50mA	1000hrs.	0/100
Steady State Operating Life		60°C, RH=90%, IF=20mA	500hrs.	0/100
of High Humidity Heat				
Steady State Operating Life		Ta=-30°C, IF=20mA	1000hrs.	0/100
of Low Temperature				

(2) CRITERIA FOR JUDGING THE DAMAGE

			Criteria for Judgement	
Item	Symbol	Test Conditions	Min.	Max.
Forward Voltage	VF	IF=20mA	-	U.S.L.*)× 1.1
Reverse Current	Ir	V _R =5V	-	U.S.L.*)× 2.0
Luminous Intensity	Iv	IF=20mA	L.S.L.**)× 0.7	-

^{*)} U.S.L.: Upper Standard Level

^{**)} L.S.L.: Lower Standard Level

7.CAUTIONS

(1) Lead Forming

- · When forming leads, the leads should be bent at a point at least 3mm from the base of the epoxy bulb. Do not use the base of the leadframe as a fulcrum during lead forming.
- · Lead forming should be done before soldering.
- · Do not apply any bending stress to the base of the lead. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- · When mounting the LEDs onto a printed circuit board, the holes on the circuit board should be exactly aligned with the leads of the LEDs. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

(2) Storage

- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Nichia and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- · Nichia LED leadframes are comprised of a silver plated copper alloy. The silver surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- · Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

(3) Soldering Conditions

- · Nichia LED leadframes are comprised of a silver plated copper alloy. This substance has a low thermal coefficient (easily conducts heat). Careful attention should be paid during soldering.
- · Solder the LED no closer than 3mm from the base of the epoxy bulb. Soldering beyond the base of the tie bar is recommended.

· Recommended soldering conditions

Dip Soldering		Soldering		
Pre-Heat	120°C Max.	Temperature	350°C Max.	
Pre-Heat Time	60 seconds Max.	Soldering Time	3 seconds Max.	
Solder Bath	260°C Max.	Position	No closer than 3 mm from the	
Temperature			base of the epoxy bulb.	
Dipping Time	10 seconds Max.			
Dipping Position	No lower than 3 mm from the			
	base of the epoxy bulb.			

- · Do not apply any stress to the lead particularly when heated.
- · The LEDs must not be repositioned after soldering.
- · After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- · Direct soldering onto a PC board should be avoided. Mechanical stress to the resin may be caused from warping of the PC board or from the clinching and cutting of the leadframes. When it is absolutely necessary, the LEDs may be mounted in this fashion but the User will assume responsibility for any problems. Direct soldering should only be done after testing has confirmed that no damage, such as wire bond failure or resin deterioration, will occur. Nichia's LEDs should not be soldered directly to double sided PC boards because the heat will deteriorate the epoxy resin.
- · When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.
- · Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.

(4) Heat Generation

- Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

(5) Cleaning

- · It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.
- · Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

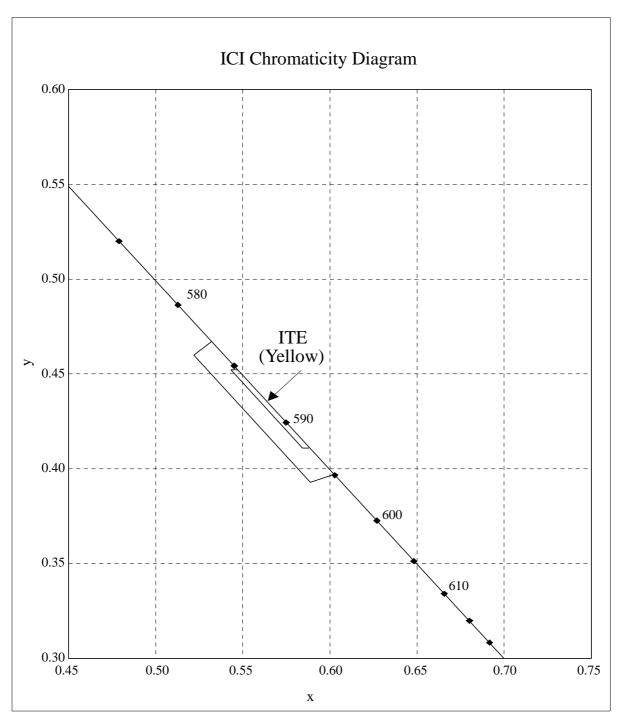
(6) Safety Guideline for Human Eyes

· In 1993, the International Electric Committee (IEC) issued a standard concerning laser product safety (IEC 825-1). Since then, this standard has been applied for diffused light sources (LEDs) as well as lasers. In 1998 IEC 60825-1 Edition 1.1 evaluated the magnitude of the light source. In 2001 IEC 60825-1 Amendment 2 converted the laser class into 7 classes for end products. Components are excluded from this system. Products which contain visible LEDs are now classified as class 1. Products containing UV LEDs are class 1M. Products containing LEDs can be classified as class 2 in cases where viewing angles are narrow, optical manipulation intensifies the light, and/or the energy emitted is high. For these systems it is recommended to avoid long term exposure. It is also recommended to follow the IEC regulations regarding safety and labeling of products.

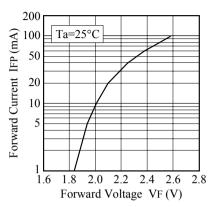
(7) Others

- · If the LEDs are being used after being fixed into a case (container, box, etc...) the LEDs must not be mounted so that the epoxy lens is pressed or glued onto a plastic (or metal) board.
- · Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- These LEDs are designed and manufactured for standard applications of traffic signals.

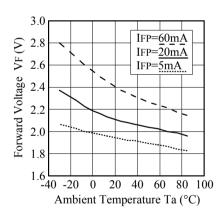
 It is recommended to consult with Nichia in advance if these LEDs are used for other applications.
- · User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the User shall inform Nichia directly before disassembling or analysis.
- · The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- The appearance and specifications of the product may be modified for improvement without notice.



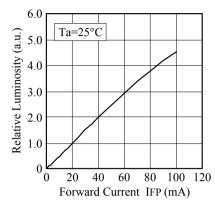
* Color Coordinates Measurement allowance is ± 0.01 .



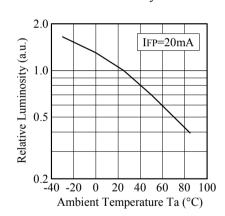
■ Ambient Temperature vs. Forward Voltage



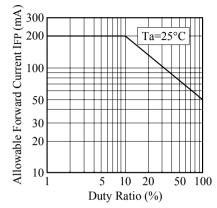
■ Forward Current vs. Relative Luminosity



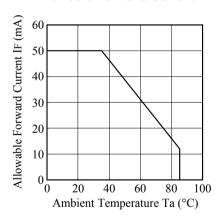
■ Ambient Temperature vs. Relative Luminosity



■ Duty Ratio vs. Allowable Forward Current



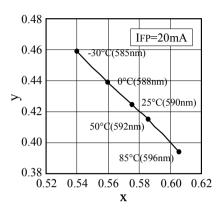
■ Ambient Temperature vs. Allowable Forward Current



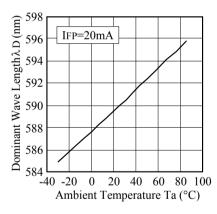
Model NSPY800AS NICHIA CORPORATION Title TYP.CHARACTERISTICS 020621205061 No.

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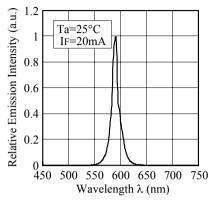
■ Ambient Temperature vs. Chromaticity Coordinate (λD)



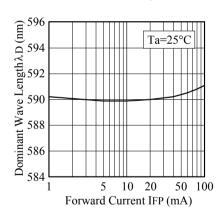
■ Ambient Temperature vs. Dominant Wavelength



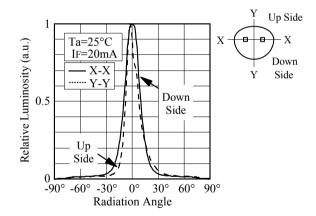
■ Spectrum



■ Forward Current vs. Dominant Wavelength



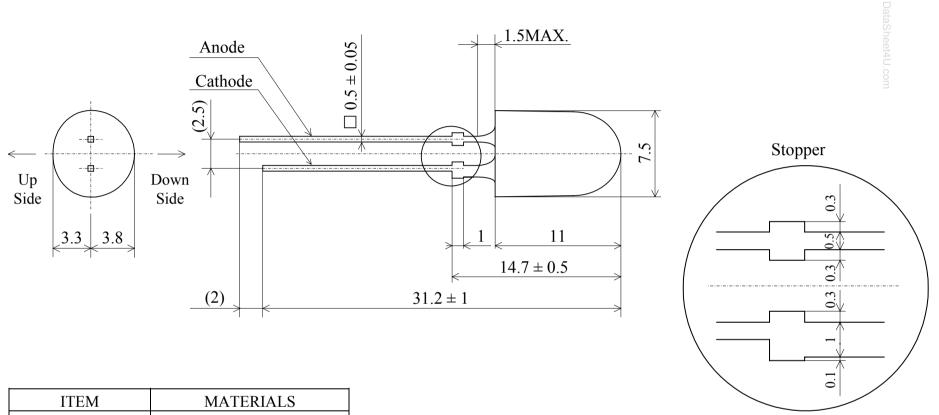
■ Directivity (NSPY800AS)



Model

NICHIA CORPORATION Title TYP.CHARACTERISTICS 020621205071 No.

NSPY800AS



ITEM	MATERIALS		
RESIN(MOLD)	Epoxy Resin		
LEAD FRAME	Ag Plating Copper Alloy		

Remark:

Bare copper alloy is exposed at tie-bar portion after cutting.

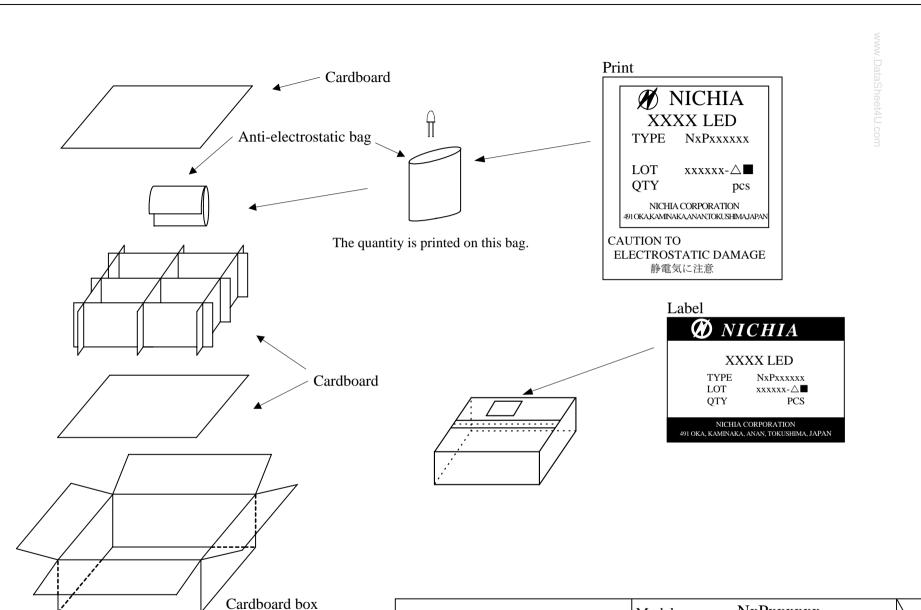
The lamps have sharp and hard points that may injure human eyes or fingers etc., so please pay enough care in the handling.

NICHIA CORPORATION	Model	NSPY800AS	Unit
	Title	OUTLINE DIMENSIONS	3/1 Scale
	No.	020621205081	Allow ±0.2

Nichia







 \star One box contains 8 bags at maximum.

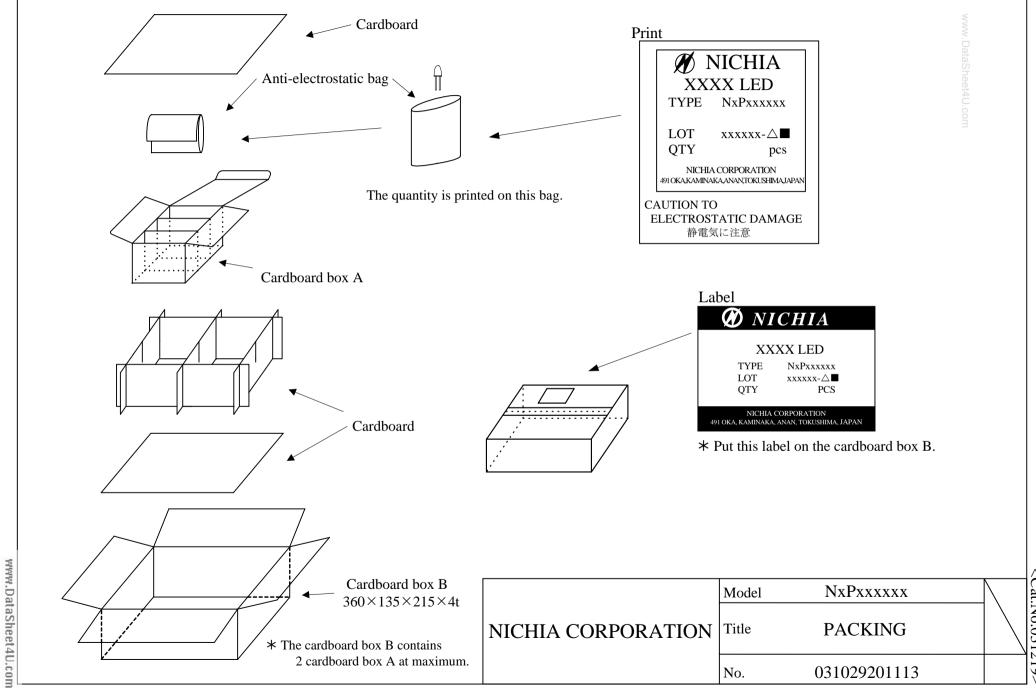
 $360 \times 135 \times 215 \times 4t$

NICHIA CORPORATION

Model NxPxxxxxx

Title PACKING

No. 031029201103



* The cardboard box B contains

2 cardboard box A at maximum.

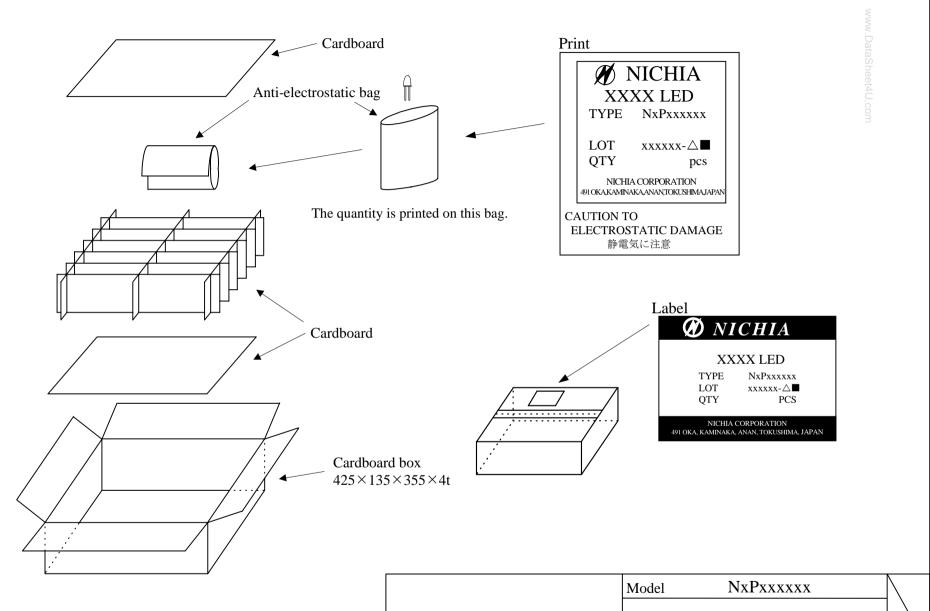
Nichia STSE-CY2095B

<Cat.No.031219>

031029201113

No.





NICHIA CORPORATION

Title

No.

PACKING

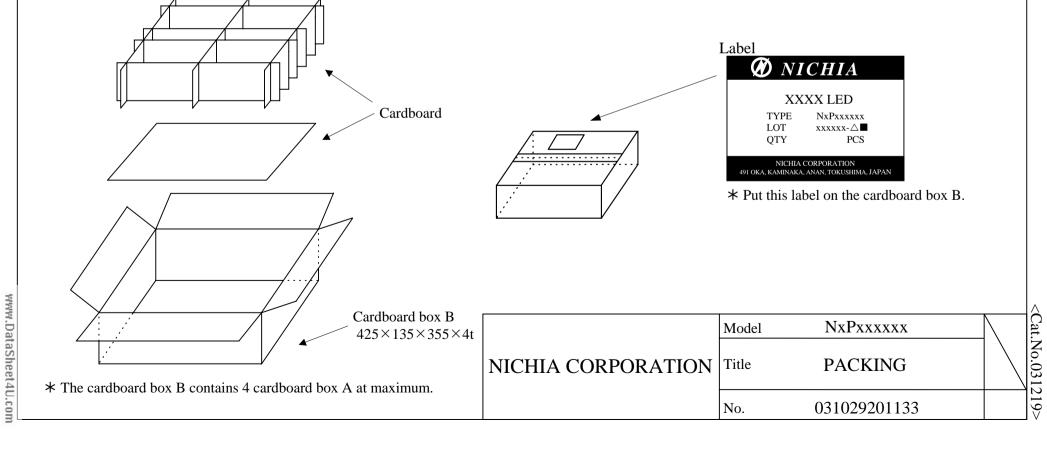
031029201123

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* One box contains 20 bags at maximum.

Nichia STSE-CY2095B <Cat.No.031219>





The quantity is printed on this bag.

Print

TYPE

LOT OTY

CAUTION TO

M NICHIA XXXX LED

NICHIA CORPORATION 491 OKA,KAMINAKA,ANAN,TOKUSHIMA,JAPAN

ELECTROSTATIC DAMAGE 静電気に注意

NxPxxxxxx

xxxxxx-△■

pcs

Cardboard

Anti-electrostatic bag

Cardboard box A

STSE-CY2095B